

Bonding Recommendation eboard EP138



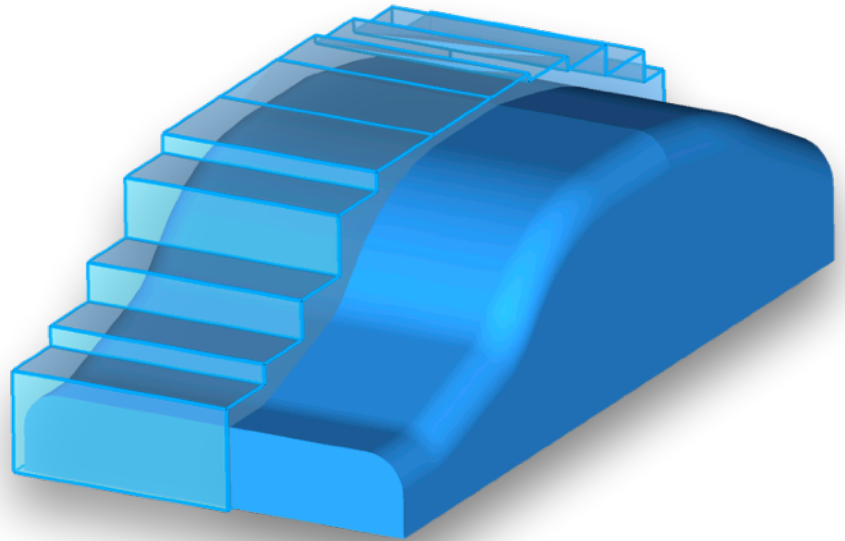
Recommended adhesives:

Adhesive EP

- Easy to apply
- Clear appearance
- Create thin bonding lines
- Low viscosity


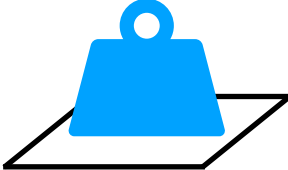

Adhesive EP LD:

- Low density adhesive
- Easy to apply
- Reduces witness lines



Adhesive guideline:

- Apply with notched trowel (e.g. A2)
- We recommend to not overlap joints
- Fix with press, clamps or vacuum bag
- Heating and cooling rates are depending on the geometry, try using sensitive heating and cooling profiles
- Segmental removal of large volumes urges supporting structures of at least the some thickness
- See technical datasheet (TDS) for more information

Adhesive EP		Adhesive EP LD
25 - 30 min	Process time 	20 min
500 - 600 g	Weight / m² 	400 - 500 g
5-6h @ RT ≥ 10h @ 80°C View TDS for more	Cure 	6-7h @ RT ≥ 10h @ 80°C View TDS for more